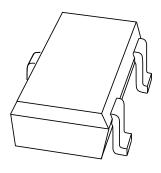
DISCRETE SEMICONDUCTORS

DATA SHEET



BFS540NPN 9 GHz wideband transistor

Product specification Supersedes data of 1997 Dec 05 2000 May 30



NPN 9 GHz wideband transistor

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FEATURES

- · High power gain
- · Low noise figure
- · High transition frequency
- Gold metallization ensures excellent reliability
- SOT323 package.

APPLICATIONS

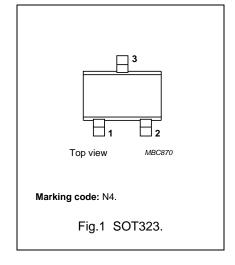
RF wideband amplifier applications such as satellite TV systems and RF portable communication equipment with signal frequencies up to 2 GHz.

DESCRIPTION

NPN transistor in a SOT323 plastic package.

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	_	20	٧
V _{CEO}	collector-emitter voltage	open base	_	_	15	V
I _C	DC collector current		_	_	120	mA
P _{tot}	total power dissipation	T _s ≤ 80 °C; note 1	_	_	500	mW
h _{FE}	DC current gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; T_j = 25 ^{\circ}\text{C}$	100	120	250	
f _T	transition frequency	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 1 \text{ GHz}; $ $T_{amb} = 25 \text{ °C}$	_	9	_	GHz
G _{UM}	maximum unilateral power gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 900 \text{ MHz}; $ $T_{amb} = 25 \text{ °C}$	_	14	_	dB
F	noise figure	$I_C = 10 \text{ mA}; V_{CE} = 8 \text{ V}; f = 900 \text{ MHz}; $ $T_{amb} = 25 \text{ °C}$	_	1.3	1.7	dB

Note

1. T_s is the temperature at the soldering point of the collector tab.

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CES}	collector-emitter voltage	R _{BE} = 0	_	15	V
V _{EBO}	emitter-base voltage	open collector	_	2.5	V
I _C	DC collector current		_	120	mA
P _{tot}	total power dissipation	T _s ≤ 80 °C; note 1	_	500	mW
T _{stg}	storage temperature		-65	150	°C
T _j	junction temperature		_	175	°C

Note

1. T_s is the temperature at the soldering point of the collector tab.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point	T _s ≤ 80 °C; note 1	190	K/W

Note

1. T_s is the temperature at the soldering point of the collector tab.

CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector cut-off current	I _E = 0; V _{CE} = 8 V	-	_	50	nA
h _{FE}	DC current gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}$	100	120	250	
Ce	emitter capacitance	$I_C = i_C = 0$; $V_{EB} = 0.5 \text{ V}$; $f = 1 \text{ MHz}$	_	2	_	pF
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 8 \text{ V}$; $f = 1 \text{ MHz}$	_	0.9	_	pF
C _{re}	feedback capacitance	I _C = 0; V _{CB} = 8 V; f = 1 MHz	_	0.6	_	pF
f _T	transition frequency	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 1 \text{ GHz}; $ $T_{amb} = 25 \text{ °C}$	-	9	_	GHz
G _{UM}	maximum unilateral power gain (note 1)	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 900 \text{ MHz}; $ $T_{amb} = 25 \text{ °C}$	-	14	_	dB
		$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 2 \text{ GHz};$ $T_{amb} = 25 \text{ °C}$	_	8	_	dB
$ s_{21} ^2$	insertion power gain	$I_C = 40 \text{ mA}; V_{CE} = 8 \text{ V}; f = 900 \text{ MHz};$ $T_{amb} = 25 \text{ °C}$	12	13	_	dB
F	noise figure	$\Gamma_{\text{s}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 10$ mA; $V_{\text{CE}} = 8$ V; $f = 900$ MHz; $T_{\text{amb}} = 25$ °C	_	1.3	1.8	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 40$ mA; $V_{\text{CE}} = 8$ V; $f = 900$ MHz; $T_{\text{amb}} = 25$ °C	_	1.9	2.4	dB
		$\Gamma_{\text{S}} = \Gamma_{\text{opt}}$; $I_{\text{C}} = 10$ mA; $V_{\text{CE}} = 8$ V; $f = 2$ GHz; $T_{\text{amb}} = 25$ °C	-	2.1	_	dB
P _{L1}	output power at 1 dB gain compression	I_c = 40 mA; V_{CE} = 8 V; R_L = 50 Ω; f = 900 MHz; T_{amb} = 25 °C	-	21	_	dBm
ITO	third order intercept point	note 2	-	34	_	dBm

Notes

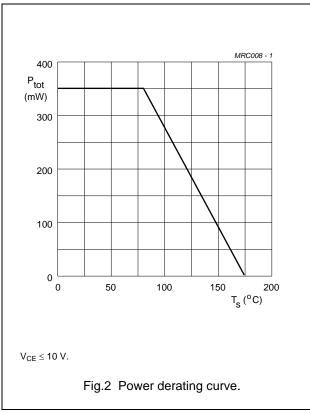
1. G_{UM} is the maximum unilateral power gain, assuming s_{12} is zero and

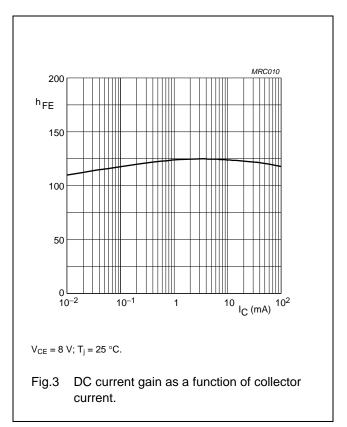
$$G_{UM} = 10 \log \frac{|s_{21}|^2}{(1-|s_{11}|^2)(1-|s_{22}|^2)} dB.$$

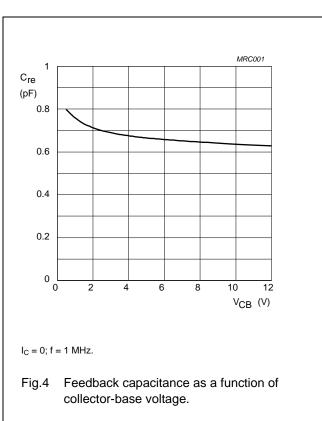
2. I_{C} = 40 mA; V_{CE} = 8 V; R_{L} = 50 Ω ; f = 900 MHz; T_{amb} = 25 °C; f_{p} = 900 MHz; f_{q} = 902 MHz; measured at $f_{(2p-q)}$ = 898 MHz and at $f_{(2q-p)}$ = 904 MHz.

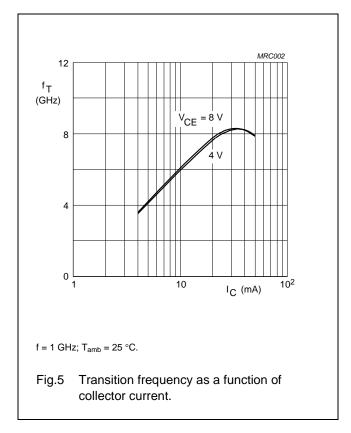
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In Figs 6 to 9, G_{UM} = maximum unilateral power gain; MSG = maximum stable gain; G_{max} = maximum available gain.

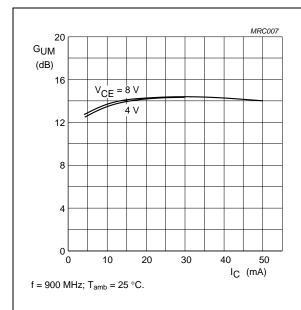
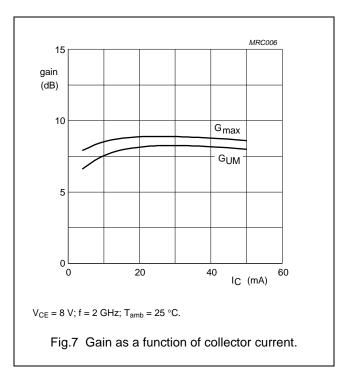
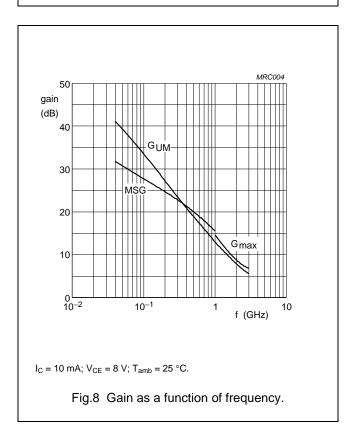
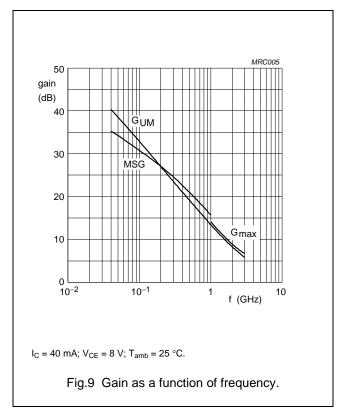


Fig.6 Maximum unilateral power gain as a function of collector current.

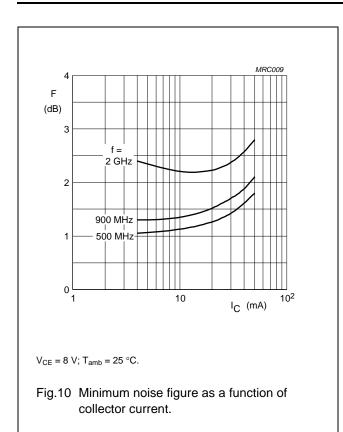






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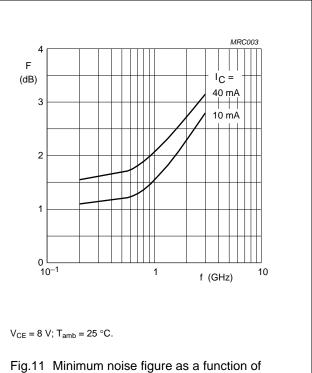
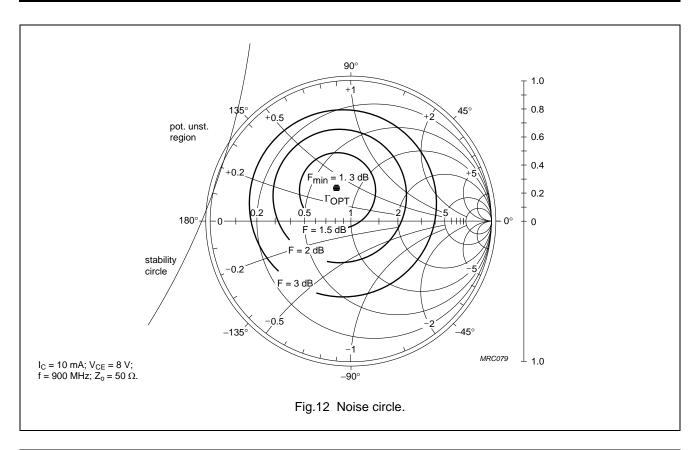
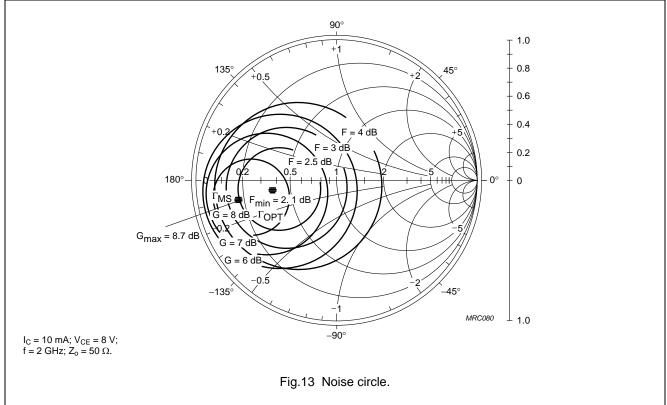


Fig.11 Minimum noise figure as a function of frequency.

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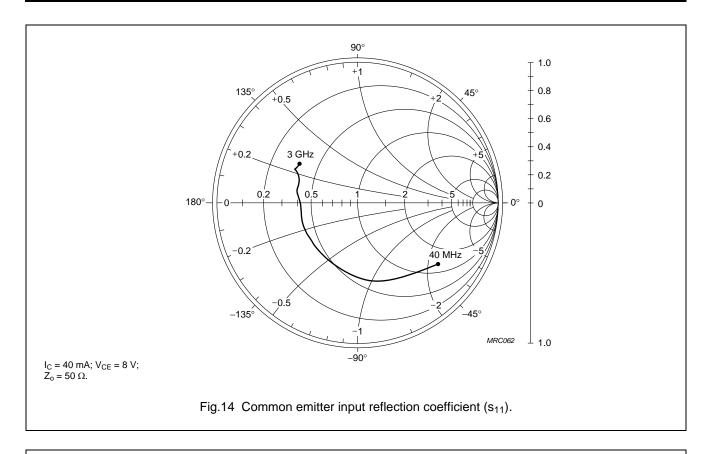
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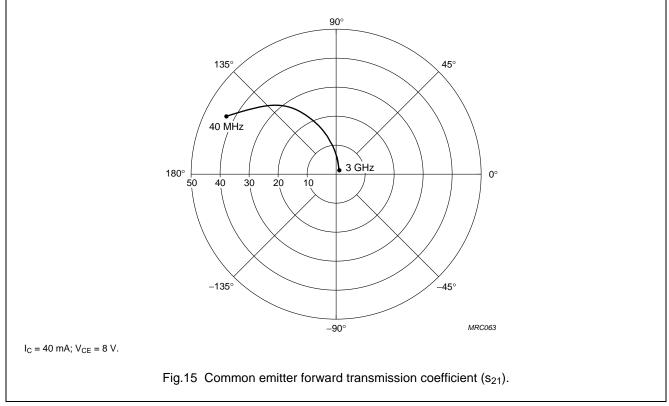




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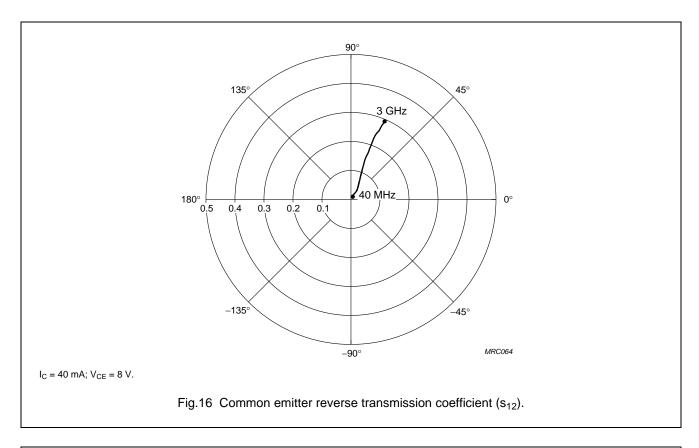
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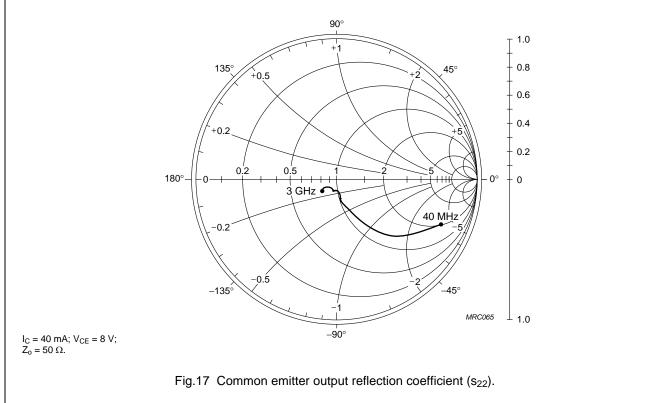




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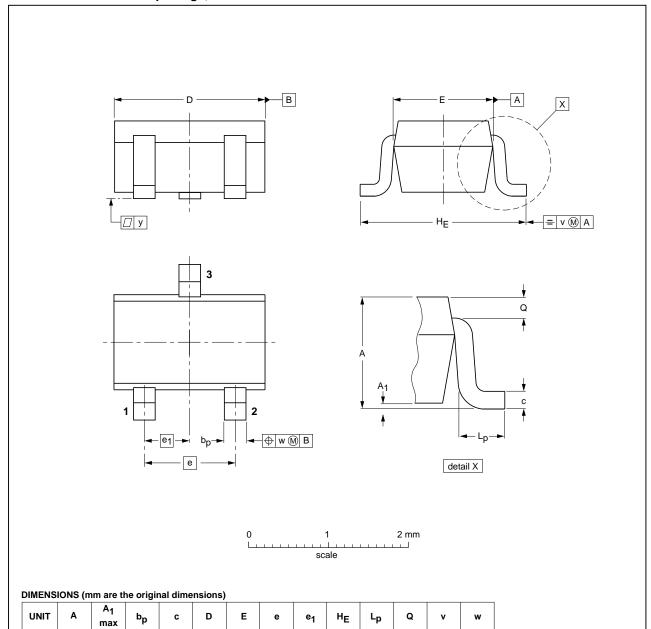
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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT323



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION ISSUE DA	
SOT323			SC-70			-04-11-04 06-03-16

2.2 2.0

0.65

0.45

0.23

0.2

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0.4 0.3

0.25

0.10

2.2

1.35

1.3

1.1 0.8

mm

0.1

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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